## N-Channel Enhancement Mode Power MOSFET

#### Description

The HM2314 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

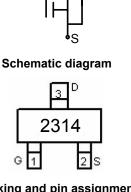
#### **General Features**

•  $V_{DS} = 20V, I_D = 4.5A$   $R_{DS(ON)} < 40m\Omega @ V_{GS} = 2.5V$  $R_{DS(ON)} < 33m\Omega @ V_{GS} = 4.5V$ 

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

#### Application

- Battery protection
- Load switch
- Power management



Marking and pin assignment



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2314	HM2314	SOT-23-3L	Ø180mm	8 mm	3000 units

#### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		VDS	20	V
Gate-Source Voltage		Vgs	±12	V
Continuous Drain Current	T <sub>A</sub> =25℃	1	4.5	A
	T <sub>A</sub> =70℃	ID	3.6	
Drain Current-Pulsed (Note 1)	·	I <sub>DM</sub>	13.5	А
Maximum Power Dissipation		PD	1.25	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ extsf{ heta}JA}$	100	°C <b>/W</b>

#### Electrical Characteristics (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	20	22	-	V

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Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =20V, $V_{GS}$ =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)		·				
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	0.5	0.65	1.2	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =2.5V, I <sub>D</sub> =4.0 A	-	33	40	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.5A	-	22	33	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =10V,I <sub>D</sub> =4A	-	10	-	S
Dynamic Characteristics (Note4)	·	·	•			
Input Capacitance	Clss		-	500	-	PF
Output Capacitance	Coss	- V <sub>DS</sub> =8V,V <sub>GS</sub> =0V, - F=1.0MHz	-	300	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	140	-	PF
Switching Characteristics (Note 4)		·				
Turn-on Delay Time	t <sub>d(on)</sub>		-	20	40	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =10V,I <sub>D</sub> =1A	-	18	40	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =4.5V, $R_{GEN}$ =6 $\Omega$	-	60	108	nS
Turn-Off Fall Time	t <sub>f</sub>		-	28	56	nS
Total Gate Charge	Qg		-	10	15	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =3A,V <sub>GS</sub> =4.5V	-	2.3	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	2.9	-	nC
Drain-Source Diode Characteristics			•	•	•	•
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =1A	-	-	1.2	V
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	1	А

Notes:

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- **2.** Surface mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse test: pulse width  $\leq$  300µs, duty cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production

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t

10%

90%

50%

90%

t<sub>d(off)</sub>

**INVERTED** 

**PULSE WIDTH** 

Figure 2:Switching Waveforms

C<sub>on</sub> t

10%

50%

90%

t<sub>d(on)</sub>

Vout

VIN

10%

## **Typical Electrical and Thermal Characteristics**

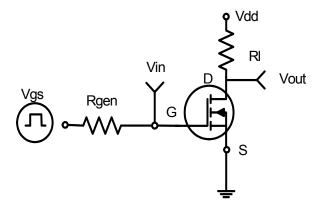
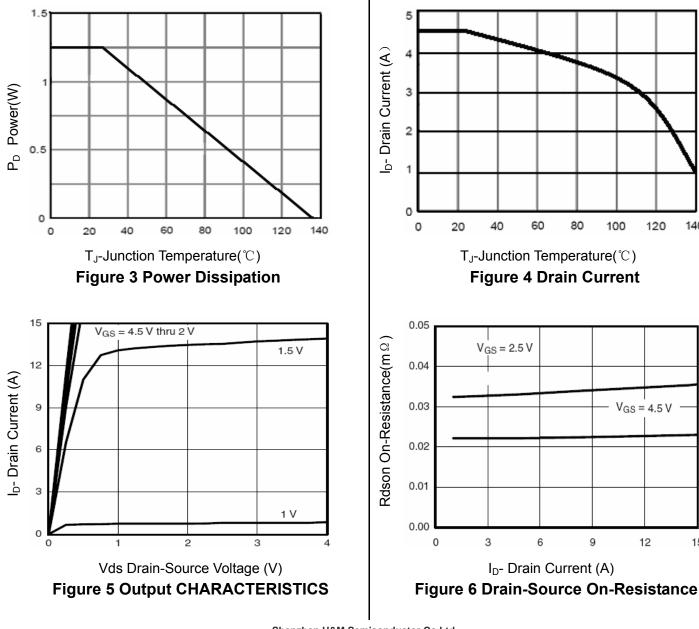


Figure 1:Switching Test Circuit

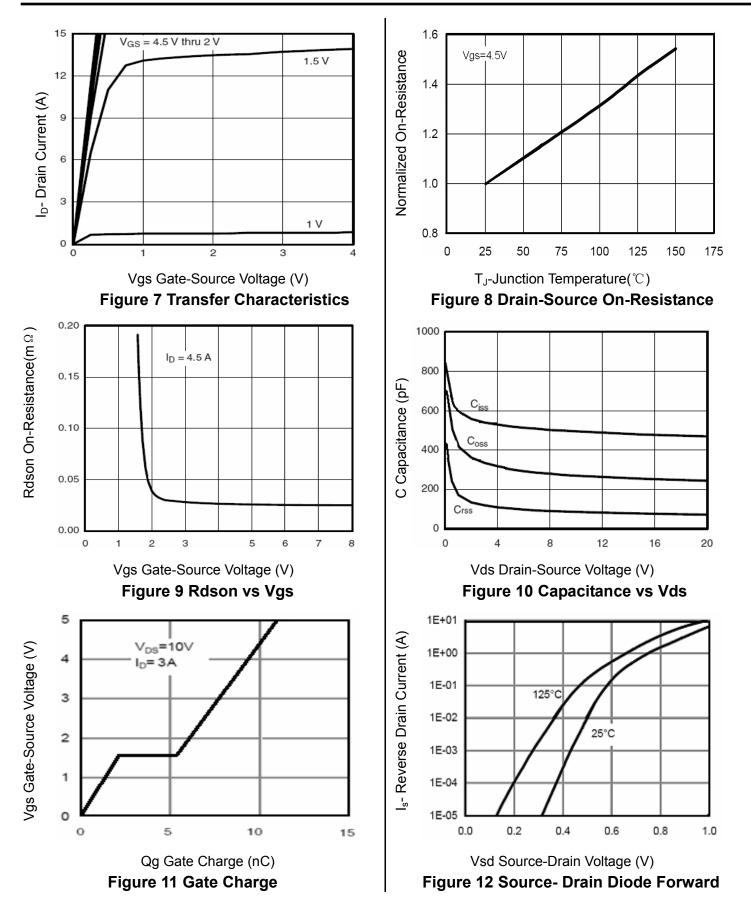


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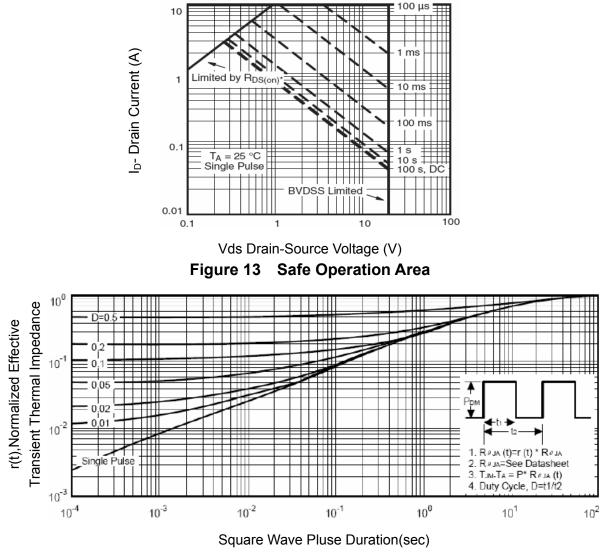
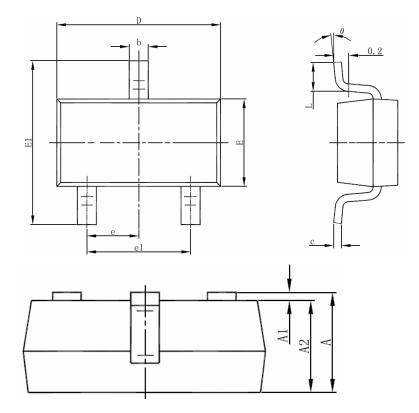


Figure 14 Normalized Maximum Transient Thermal Impedance

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# SOT-23-3L PACKAGE INFORMATION



Symbol	Dimensions Ir	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950	(BSC)	0.037(	BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	

### NOTES

1. All dimensions are in millimeters.

2. Tolerance ±0.10mm (4 mil) unless otherwise specified

3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.

4. Dimension L is measured in gauge plane.

5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

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